TOSHIBA PHOTOCOUPLER GaAIAs IRED & PHOTO-IC

# **TLP554**

ISOLATED LINE RECEIVER SIMPLEX/MULTIPLEX DATA TRANSMISSION COMPUTER-PERIPHERAL INTERFACE MICROPROCESSOR SYSTEM INTERFACES DIGITAL ISOLATION FOR A/D,D/A CONVERSION

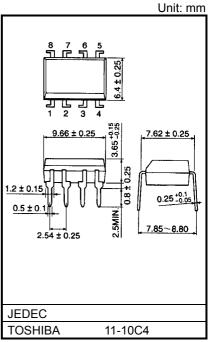
The TOSHIBA TLP554 a photocoupler which combines a GaAlAsIRED as the emitter and an integrated high gain,high speed photodetector. The output of the detector circuit is an open collector,Schottky Clamped transistor.

A Faraday shield integrated on the photodetector chip reduces the effects of capacitive coupling between the input LED emitter and the high gain stages of the detector. This provides an effective common mode transient immunity of 1000V/us.

Input Current Threshold : IF=5mA(Max.)
 Switching Speed : 10MBd(TYP,@NRZ)
 Common mode transient immunity : ±1000V/us(Min)
 Guaranteed PerformanceOverTemperature : 0~70°C

Isolation Voltage : 2500Vrms(Min)

UL Recognized :UL1577,File No.E67349

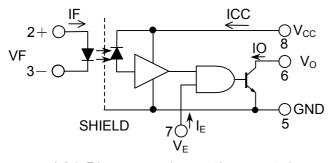


Weight: 0.54 g

### TRUTH TABLE(Positive Logic)

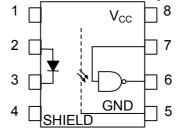
INPUT	ENABLE	OUTPUT
Н	Н	L
L	Н	Н
Н	L	Н
L	L	Н

### **SCHEMATIC**



A  $0.1\mu F$  bypass capacitor must be connected Between pins 8 and 5.(See Note 1)

### **PIN CONFIGURATION (TOP VIEW)**



2:ANODE 3:CATHODE 4:N.C. 5:GND 6:V<sub>O</sub>(OUTPUT) 7:V<sub>E</sub>(ENABLE) 8:V<sub>CC</sub>

1:NC

### RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Low Level input Voltage	VFL	-3	0	1.0	V
High Level input current	IFH	6.3*		20	mA
Supply Voltage	VCC	4.5	5	5.5	V
High-Level Enable Voltage	VEH	2.0	_	VCC	V
Low-Level Enable Voltage	VEL	0	_	0.8	V
Fan Out(TTL Load)	N	_	_	8	_
Operating Temperature	Topr	0		70	°C

<sup>\*6.3</sup>mA condition permits at least 20% CTR degradation Initial switching threshold is 5.0mA or less.

### **MAXIMUM RATINGS (Ta = 25°C)**

	CHARACTERISTIC	SYMBOL	RATING	UNIT	
LED	Forward Current	I <sub>F</sub>	20	mA	
쁘	Reverse Voltage	$V_{R}$	5	V	
	Output Current	Ю	25	mA	
OR.	Output Voltage			-0.5~7	V
ECT	Output Voltage Supply Voltage (iiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiii		VCC	7	V
DET			VE	5.5	V
			РО	40	mW
Storage Temperature Range			T <sub>stg</sub>	-55~125	°C
Operating Temperature Range			T <sub>opr</sub>	-40~85	°C
Lead Soldering Temperature (10 s) (Note 4)			T <sub>sol</sub>	260	°C
Isolation Voltage (AC, 1 minute, R.H.≤ 60%) (Note 5)			$BV_S$	2500	Vrms

- (Note 1) The  $V_{\text{CC}}$  supply voltage to each TLP554 isolator must be bypassed by a  $0.1 \mu\text{F}$  capacitor or larger. This can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to the package  $V_{\text{CC}}$  and GND pins each device.
- (Note 2) 1 Minute Maximum.
- (Note 3) Not to exceed VCC by more than 500mV.
- (Note 4) 2mm below seating plane.
- (Note 5) Device considered a two-terminal device :Pins 1,2,3 and 4 shorted together,and Pins 5, 6,7 and 8 shorted together.

# ELECTRICAL CHARACTERISTICS (Ta = 0~70°C , VCC=4.5~5.5V , VFL≤1.0V)

CHARACTERISTIC		SYMBOL	TEST CONDITION		MIN.	TYP.*	MAX.	UNIT
Forward Voltage		V <sub>F</sub>	I <sub>F</sub> = 10 mA , Ta=25°C			1.65	1.80	٧
Temperature Coeffic Voltage	ient of Forward	ΔVF/ΔΤα	$I_F = 10 \text{ mA}$ ,		_	-2.0	_	mV/°C
Input Reverse Currer	nt	I <sub>R</sub>	V <sub>R</sub> =5V, Ta=25°C		_		10	μА
Input Capacitance		Ст	V = 0 , f = 1MHz , Ta=25°C		_	45	_	pF
High-Level Output Current		IOH V	VF = 1.0V VO = 5.5V	Ta=0~70°C		10	250	- μΑ
			VE = 2.0V	Ta=25°C		0.5	10	
Low-Level Output Voltage		VOL	IF=5mA , VE=2.0V , IOL=13mA		_	0.4	0.6	V
High Level input current		IFH	IOL=13mA , VE=2.0V , VOL=0.6V			_	5	mA
Supply Current	High Level	ICCH	VCC=5.5V	IF=0mA		7	15	- mA
очры очноп	Low Level	ICCL	VE=0.5V	IF=10mA	_	12	19	
	High Level	IEH		VE=2.0V		-1.0	_	
Enable Current	Low Level	IEL	VCC=5.5V	VE=0.5V	_	-1.6	-2.0	mA
Enable Voltage	High Level	VEH		— (Note 6)	2.0			V
	Low Level	VEL	_		_	_	0.8	
Capacitance (Input-Output)		CS	VS=0 , f=1MHz , Ta=25°C			0.6		pF
Resistance (Input-Output)		RS	VS=500V , Ta	5×10 <sup>10</sup>	10 <sup>14</sup>		Ω	

<sup>(\*)</sup>All typ.values are at Ta=25°C

<sup>(</sup>Note 6) No pull up resistor required as the device has an internal pull up resistor.

## SWITCHING CHARACTERISTICS (Ta = 25°C , Vcc=5V)

CHARACTERISTIC		SYMBOL	TEST CIRCUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Propagation Delay Time	L→H	tpLH	1	RL=350Ω	IF=7.5→0mA	_	60	120	ns
	H→L	tpHL		CL=15pF	IF=0→7.5mA	_	60	120	
Output Rise Time(10-90%)		tr	'	IF=7.5→0 / 0→7.5mA RL=350 Ω , CL=15pF		_	30	_	ns
Output Fall Time(10-90%)		tf				_	30	_	
Enable Propagation Delay Time		tELH	- 2	RL=350Ω CL=15pF IF=7.5 mA	VE=0.5→3.0V	_	25	_	
		tEHL	2		VE=3.0→0.5V	_	25	_	ns
Common Mode Transient Immunity at Hight Level CM <sub>H</sub> Outout		_	VCM=400V	IF=0mA VO(Min)=2.0V	1000	10000	_		
Common Mode Transient Immunity at Low Level Outout		CM <sub>L</sub>	3	RL=350Ω (Note 7)	IF=7.5mA VO(Max)=0.8V	-1000	-10000	_	V/μs

(Note 7)  $\text{CM}_{\text{H}}\cdot\text{The}$  maximum tolerable rate of rise of the common mode voltage to ensure

the output will remain in the high state(i.e.,VOUT>2.0V)

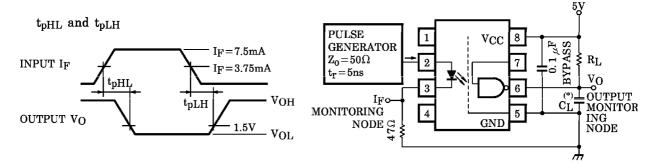
CM<sub>L</sub>·The maximum tolerable rate of fall of the common mode voltage to ensure

the output will remain in the low output state(i.e.,VOUT<0.8V)

Measured in volts per microsecond(V/µs).

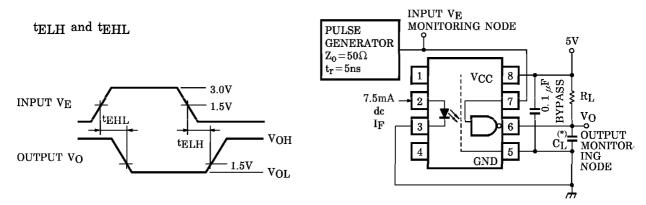
(Note 8) Maximum electrostatic discharge voltage for any pins:180V(C=200pF,R=0)

### TEST CIRCUIT 1.



(\*) CL is approximately 15pF which includes probe and stray wiring capacitance.

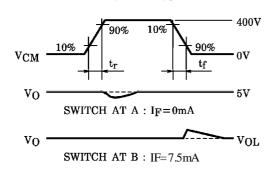
### TEST CIRCUIT 2.

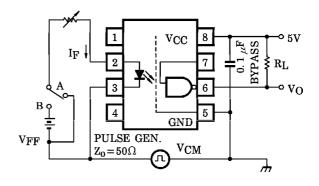


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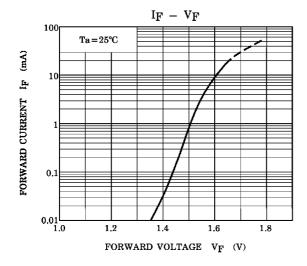
### TEST CIRCUIT 3.

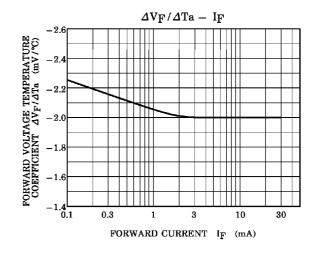
Transient Immunity and Typ. Waveforms.

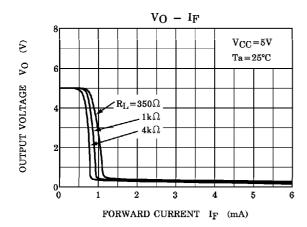


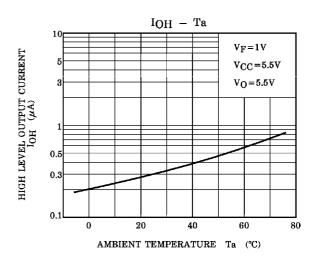


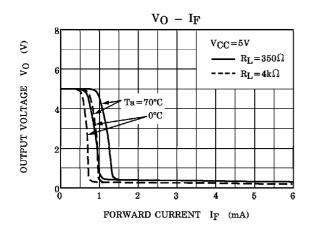
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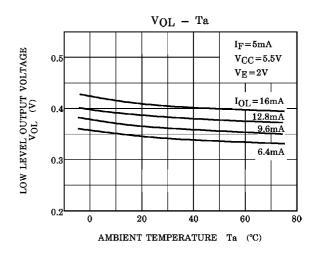




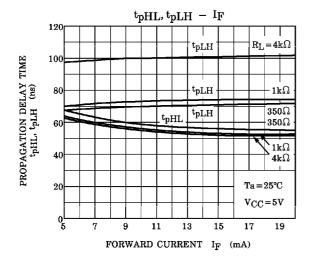


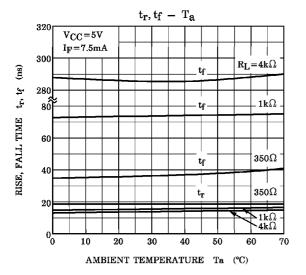


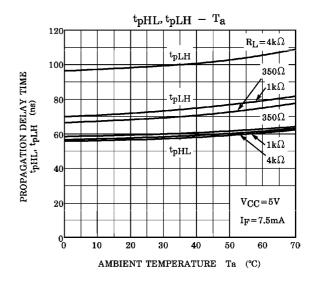


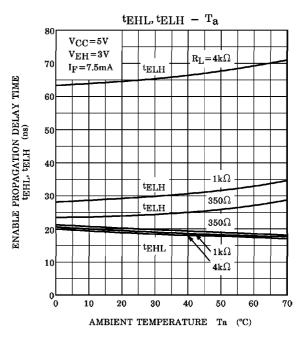


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